

December 14, 2018

Product Information

Packaging material for PFC capacitors from India

On the basis of new environmental protection regulations in India, some of the packaging material for PFC capacitors from the Nashik plant is being replaced. Previously, the affected capacitors were protected in the carton with EPE foam (expanded polyethylene). As plastic and EPE foam has now been banned in Maharashtra, India, and may no longer be used, corrugated cardboard will be used instead starting in March 2019. The new material offers the capacitors just as much protection against damage in transit. This has been confirmed in corresponding tests.

Affected products

Ordering code	Type
B25667*	PhasCap® Premium
B25673*	PhaseCap® Compact
B32340*	PhiCap™
B32343*	PhiCap™
B32344*	PhiCap™

Figure:
Examples of existing and new packaging



Scheduled date of introduction: March 1, 2019

During a transitional period existing and new packaging may be shipped.

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Customers are asked to address inquiries directly to their sales contacts.

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Power Capacitors
Internal / External

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